

#### **GENERAL DESCRIPTION**

The CL9193 is a low-dropout voltage regulator designed for portable and wireless applications that require high PSRR, low quiescent current and excellent line and load transient response.

The CL9193 is designed to work with small 1uF input and output ceramic capacitors.

: 2.0V ~ 6.0V

: 70dB @ 1KHz

: 150mV @ 100mA

:Current Limit &

Short Protect

: 40uA (Typ.)

: 300mA

: < 0.1uA

The CL9193 consumes less than 0.1uA in shutdown mode. The CL9193 is available in 5 pin SOT23-5L packages. The output standards of 1.2V, 1.3V, 1.5V, 1.8V, 2.0V, 2.5V, 2.7V, 2.8V, 3.0V, and 3.3V are available.

#### FEATURES

Input Range

High PSRR

Dropout Voltage

Protection

CDMA/GSM mobile phone
PDAs/MP3

**APPLICATIONS** 

- WLAN and bluetooth appliances
- Cordless telephones
- Battery powered portable devices

#### SOT23-5L Package Available

## TYPICAL APPLICATIONS

Maximum Output Current

Low Quiescent Current

Shutdown Mode Current

Operation Ambient Temperature : -40 ~ +85°C





#### **PIN CONFIGURATION**

SOT23-5L



## **PIN FUNCTIONS**

SOT23-5	PIN NAME	FUNCTIONS
1	VIN	Power Input
2	GND	Ground
3	CE	Chip Enable
4	NC	No Connection
5	Vout	Output

## ESD & Latch-up Level

HBM ESD	4000V
MM ESD	400 V
Latch-up	400mA



# CL9193 300mA High PSRR LDO



# **ABSOLUTE MAXIMUM RATINGS**

PARAMETER	SYMBOL	RATING	UNITS
INPUT VOLTAGE	VIN	6	V
OUTPUT CURRENT	IOUT	500	mA
OUTPUT VOLTAGE	Vout	GND-0.3 ~ VIN +0.3	V
POWER DISSIPATION (SOT23-5L)	Pd	400	mW
OPERATING TEMP.	Topr	-25 ~ +85	°C
STORAGE TEMP.	Tstg	-40 ~ +125	°C
LEAD TEMP.	Tsolder	260°C, 10s	



# ELECTRICAL CHARACTERISTICS

(VIN = VOUT +1V,CIN=COUT=1uF,Ta=25°C, unless otherwise stated)

PARAMETER	SYMBOL	CONDITIO	ONS	MIN	ТҮР	МАХ	UNITS
Input Voltage	Vin					6.0	V
Output Voltage	Vout	IOUT=40mA, Vo	OUT<1.5V	X 0.97	VOUT(T) <sup>Note1</sup>	X 1.03	V
		IOUT=40mA, Vo	OUT≥1.5V	X 0.98	VOUT(T) <sup>Note1</sup>	X 1.02	V
Max. Output Current	lout(max)	VIN=VOUT	-+1V	300			mA
	Load Regulation $\Delta VOUT$	VIN=VOUT+1V 1mA≤IOUT≤100mA	VOUT=1.2V		20		mV
Load Regulation	ΔVOUT		VOUT=2.5V		25		
			VOUT=3.3V		30		
			VOUT=1.2V		600		mV
Dropout Voltage	Vdif	IOUT =100mA	VOUT=2.5V		200		mV
		V	VOUT=3.3V		150		
Supply Current	IQ	VIN= VOUT +1V			40		uA
Standby Current	ISTDBY	VCE=0	V		<0.1		uA
Line Regulation	$\frac{\Delta \text{Vout}}{\Delta \text{Vin * Vout}}$	IOUT =40mA VOUT+1V≤V			0.05		%/V
CE "H" Threshold	VCEH	VIN=5	/	1.4			
CE "L" Threshold	VCEL	VIN=5	/			0.4	
Ripple Rejection Rate	PSRR	VIN= [VOUT +1]V IOUT =40mA,f=1kH			70		dB

NOTE:

1. VOUT(T)=Specified Output Voltage



# PACKAGE INFORMATION: SOT-23-5L



Symbol	Dimensions In Millim	eters	Dimensions In Inches		
- <b>J</b>	Min	Max	Min	Мах	
А	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
Е	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
е	0.950 (BSC)		0.037 (BSC)		
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
r	0°	8°	0°	8°	



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